

# SPICE Device Model Si7540DP Vishay Siliconix

## N- and P-Channel 30-V (D-S) MOSFET

### **CHARACTERISTICS**

- N- and P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

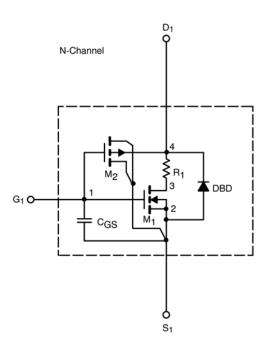
- · Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

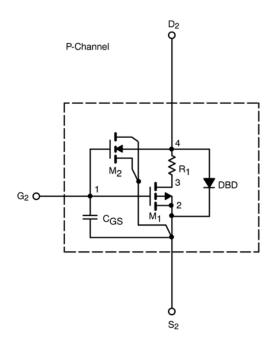
### **DESCRIPTION**

The attached spice model describes the typical electrical characteristics of the n- and p-channel vertical DMOS. The subcircuit model is extracted and optimized over the  $-55\ to\ 125^{\circ}C$  temperature ranges under the pulsed 0-V to 5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{\rm gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

### SUBCIRCUIT MODEL SCHEMATIC





This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

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Parameter	Symbol	Test Condition		Simulated Data	Measured Data	Unit
Static				!		
Gate Threshold Voltage	V	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	N-Ch	1.1		٧
	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	P-Ch	1.1		
On-State Drain Current <sup>a</sup>		$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	149		А
	I <sub>D(on)</sub>	$V_{DS} \leq -5 \text{ V}, \text{ V}_{GS}$ = $-4.5 \text{ V}$	P-Ch	104		
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 11.8 A	N-Ch	0.013	0.014	Ω
	r <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -8.9 \text{ A}$	P-Ch	0.025	0.026	
		$V_{GS} = 2.5 \text{ V}, I_D = 9.8 \text{ A}$	N-Ch	0.021	0.020	
		$V_{GS} = -2.5 \text{ V}, I_D = -6.9 \text{ A}$	P-Ch	0.044	0.043	
Forward Transconductance <sup>a</sup>		V <sub>DS</sub> = 5 V, I <sub>D</sub> = 11.8 A	N-Ch	24	32	S
	g <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_D = -8.9 \text{ A}$	P-Ch	24	23	
Diode Forward Voltage <sup>a</sup>	.,	I <sub>S</sub> = 2.9 A, V <sub>GS</sub> = 0 V	N-Ch	0.83	0.77	V
	V <sub>SD</sub>	$I_S = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$	P-Ch	0.83	-0.80	
Dynamic <sup>b</sup>	-			•		
Total Gate Charge	$Q_g$	N-Channel $V_{DS}$ = 6 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 11.8 A P-Channel $V_{DS}$ = -6 V, $V_{GS}$ = -4.5 V, $I_{D}$ = -8.9 A	N-Ch	11.4	11.5	nC
			P-Ch	13.7	13	
Gate-Source Charge	$Q_gs$		N-Ch	3.2	3.2	
			P-Ch	4.1	4.1	
Gate-Source Charge	$Q_{qs}$		N-Ch	2.5	2.5	
	∽ys		P-Ch	1.9	1.9	
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 6 \text{ V}, R_{L} = 6 \Omega$	N-Ch	23	30	
			P-Ch	44	35	
Rise Time	t <sub>r</sub>		N-Ch	28	50	
	ч	$I_D \simeq 1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 6 \Omega$	P-Ch	20	42	
Turn-Off Delay Time	$t_{d(off)}$	$\begin{array}{c} \text{P-Channel} \\ \text{V}_{\text{DD}} = -6 \text{ V}, \text{ R}_{\text{L}} = 6  \Omega \\ \text{I}_{\text{D}} \cong -1 \text{ A}, \text{ V}_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{G}} = 6  \Omega \\ \end{array} \begin{array}{c} \text{P-Ch} \\ \text{N-Ch} \\ \end{array}$	39	60	ns	
			P-Ch	21	54	113
Fall Time	t <sub>f</sub>		N-Ch	52	25	
	ч		P-Ch	12	17	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>S</sub> = 2.9 A, di/dt = 100 A/μs	N-Ch	17	40	
	·rr		P-Ch	26	40	

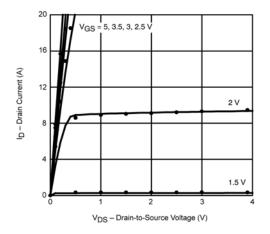
a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2\%.$  b. Guaranteed by design, not subject to production testing.

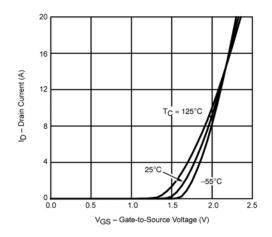


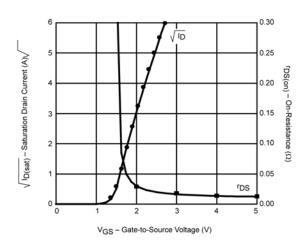
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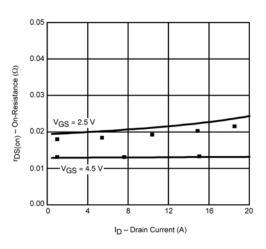
COMPARISON OF MODEL WITH MEASURED DATA (TJ=25°C UNLESS OTHERWISE NOTED)

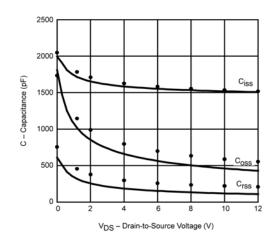
### **N-Channel MOSFET**

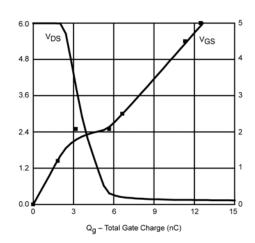












Note: Dots and squares represent measured data.

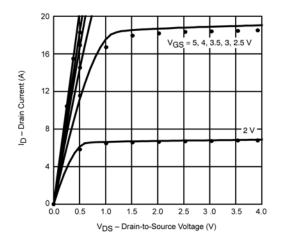
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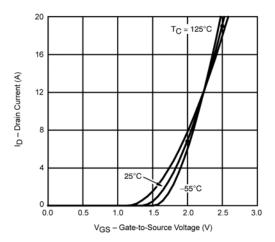
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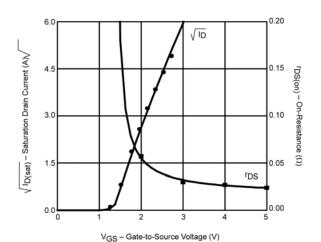
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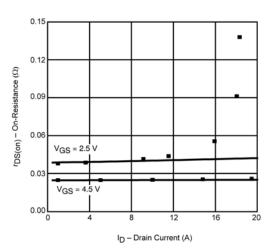


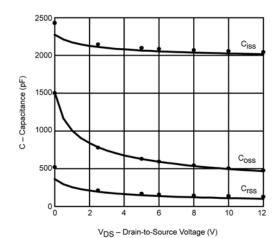


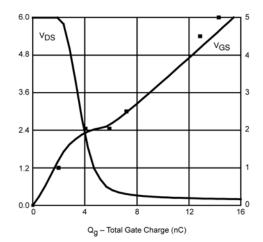












Note: Dots and squares represent measured data



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